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PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Huilong ZHU	12/09/2011
Haizhou YIN	12/09/2011
Zhijiong LUO	12/09/2011

RECEIVING PARTY DATA

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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13381014

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Total Attachments: 3

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> PATENT REEL: 027447 FRAME: 0757

OP \$40.00 13381014

Attorney Docket Number: 6075-2pus

ASSIGNMENT

In consideration of One Dollar (\$1.00), and other good and valuable consideration, the

receipt of which is hereby acknowledged, We the undersigned, Huilong ZHU, Haizhou YIN,

Zhijiong LUO (hereinafter referred to as "ASSIGNOR"):

Hereby sell, assign and transfer to Institute of Microelectronics, Chinese Academy of

Sciences, (hereinafter referred to as "ASSIGNEE"), an institute of China having a place of business

at No.3 Beitucheng West Road, Chaoyang District, Beijing 100029, China; its successors, assigns

and legal representatives, the entire right, title and interest for the United States and all foreign

countries, in and to the invention which is disclosed in the application for United States Letters

Patent, which is the U.S. national stage application of International PCT Application No.

PCT/CN2011/072961, filed on April 18, 2011, and which is entitled

METHOD FOR FORMING SEMICONDUCTOR STRUCTURE

and in and to said application and all provisional, divisional, continuing, substitute, renewal, reissue,

and all other applications for Letters Patent which have been or shall be filed in the United States

and all foreign countries on said invention; and in and to all original, reissued and other patents and

certificates of invention which have been or shall be issued in the United States and all foreign

countries on said invention;

PATENT REEL: 027447 FRAME: 0758 Agree that said Assignee may apply for and receive Letters Patent for said invention in its own name, and that, when requested, without further consideration from or charge to, but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on said invention; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said invention and for vesting title to said invention and all applications for patents and all patents on said invention, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

PATENT REEL: 027447 FRAME: 0759

IN TESTIMONY WHEREOF, we have hereunto set our hands.

First Assignor Assignor Name: "	Zhu, Hullong
•	
Assignor Address	: 93 Autumn Dr. Poughkeepsie, New York 12803.
United States of A	22222
Citizenship:	
Signature:	
Date:	()
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Signature:	-/W
Date:	<u> </u>
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Citizenship:	
Signature:	
Date:	
	Witness

Note: Signature of a witness is preferable, but <u>not</u> required.

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